

# Discussion of 400GbE DMT level diagram for realistic implementation

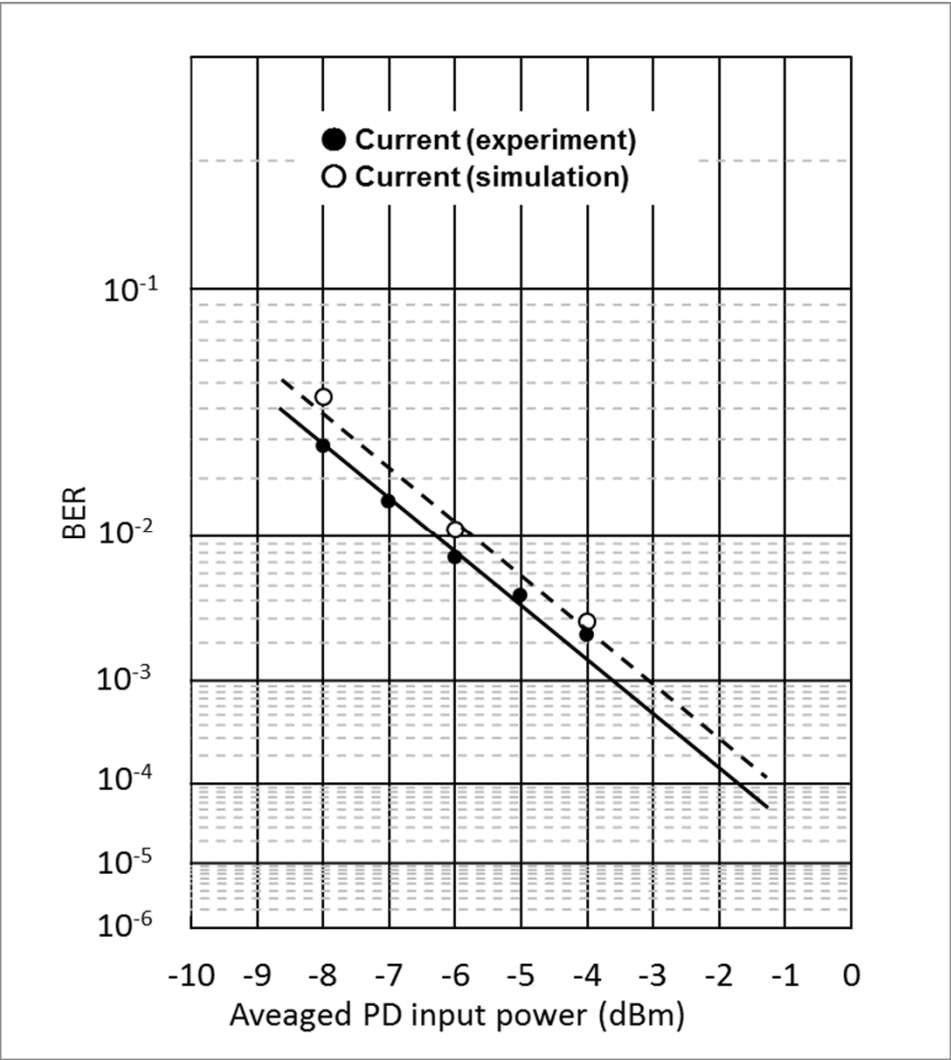
Tomoo Takahara, Hideki Isono, Hisaya Sakamoto, Yuji Miyaki  
- Fujitsu Optical Components  
Toshiki Tanaka - Fujitsu Limited

# Supporters

Sacha Corbeil	JDSU
David Lewis	JDSU
Patricia Bower	Fujitsu Semiconductor
Ian Dedic	Fujitsu Semiconductor
Markus Weber	Fujitsu Semiconductor
Michela Svaluto	CTTC

- Design tool for DMT was established based on VPItransmissionMaker and MATLAB.
- Accuracy of simulation model is demonstrated by feeding with real device parameters and compare with experiment.
- High sensitivity is demonstrated with production level device parameters.
- Reasonable level diagram is discussed based on the simulation.

# Confirmation of design tool



Bitrate  
SC

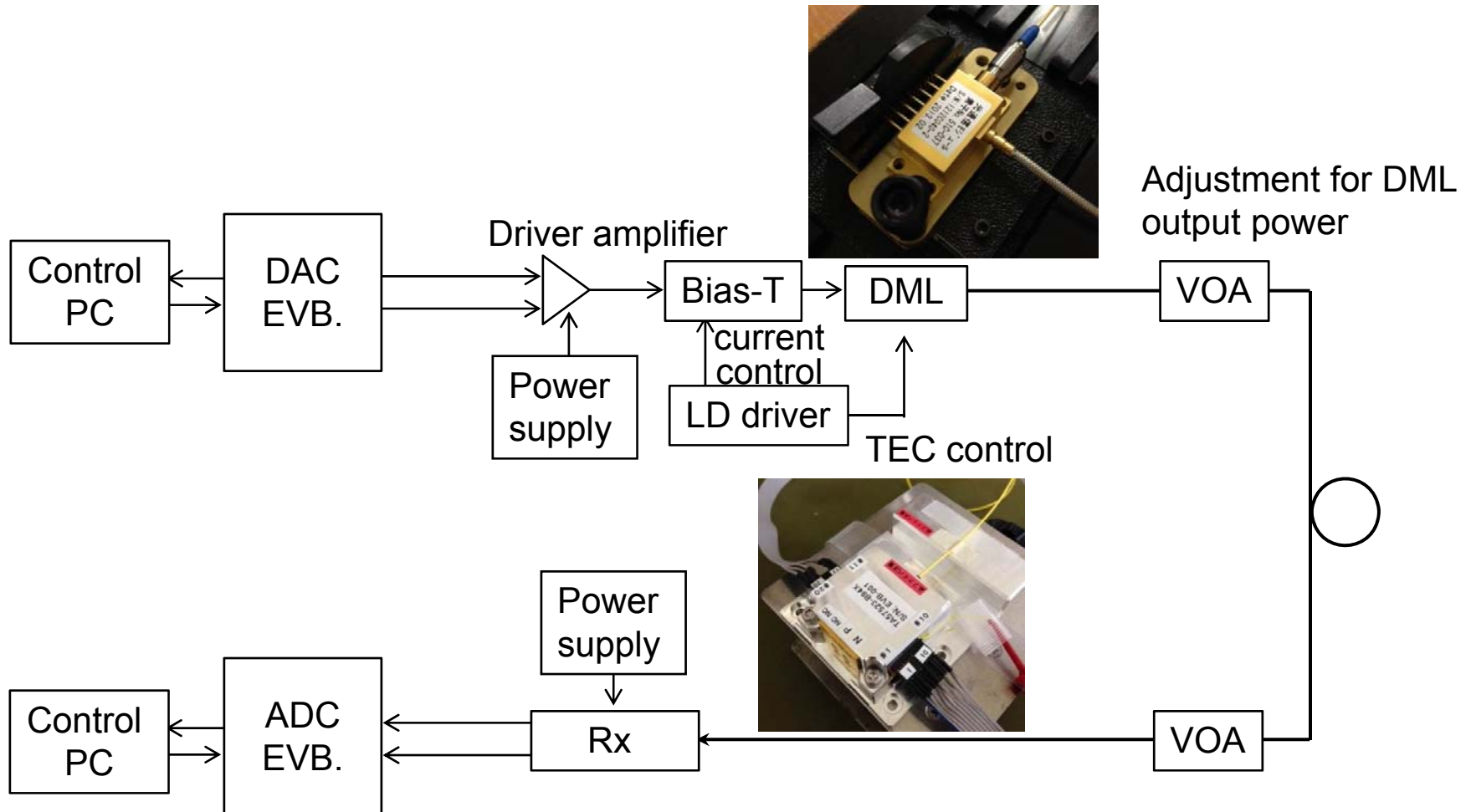
116 Gbps  
256

**Good agreement was confirmed.**

# Experimental set up

The confirmation of design tool was done by sensitivity comparison between experiment and simulation.

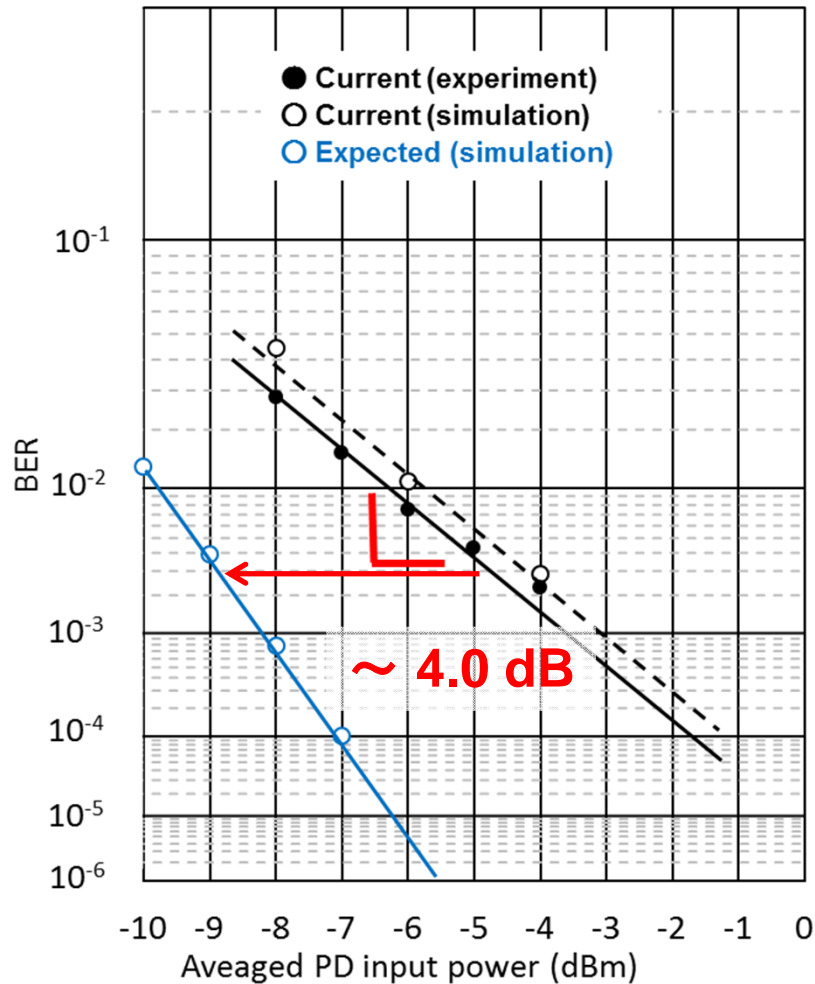
Accuracy is demonstrated by feeding with real device parameters and compare with the experimental result.



# Simulation parameters

Parameter	Experiment	Target	Unit	
FEC OH	12.5	←	%	
FEC	BCH(9193,8192)	←		
Bit rate	116.015625	←	Gbps	
Subcarrier number	256	←		
Cyclic prefix	16	←		
Clipping ratio	3.16	←		
Sampling rate	64	←	GS/s	
TX bandwidth	12	18	GHz	EVB. Impairment was included
RX bandwidth	16	21	GHz	EVB. Impairment was included
Optical modulation index	0.42	0.45		
DML RIN	-148	←	dB/Hz	
Input referred noise	20	12	pA/ $\sqrt{\text{Hz}}$	Linear new TIA will be selected

# Expected improvement of receiver sensitivity



116 Gbps

SC: 256

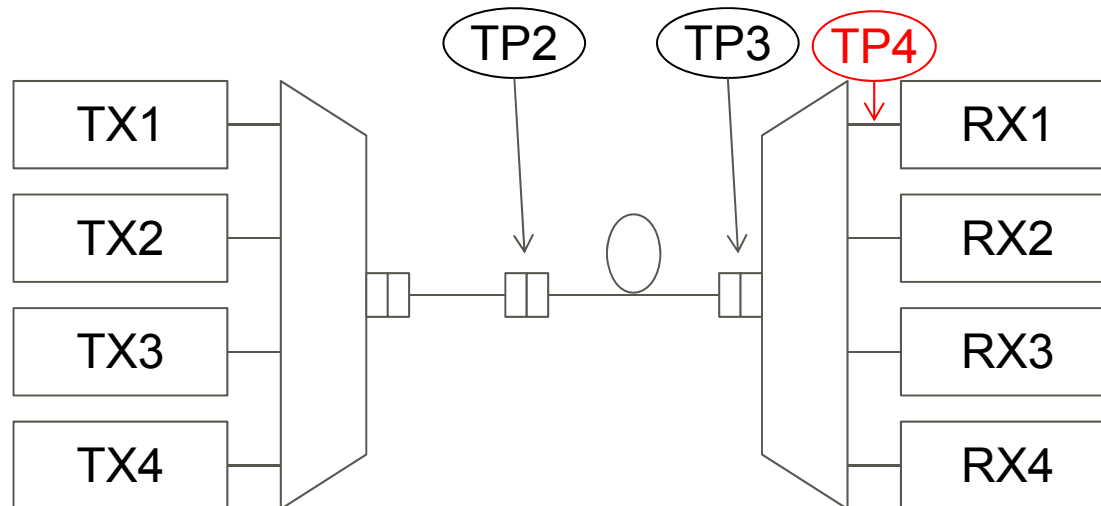
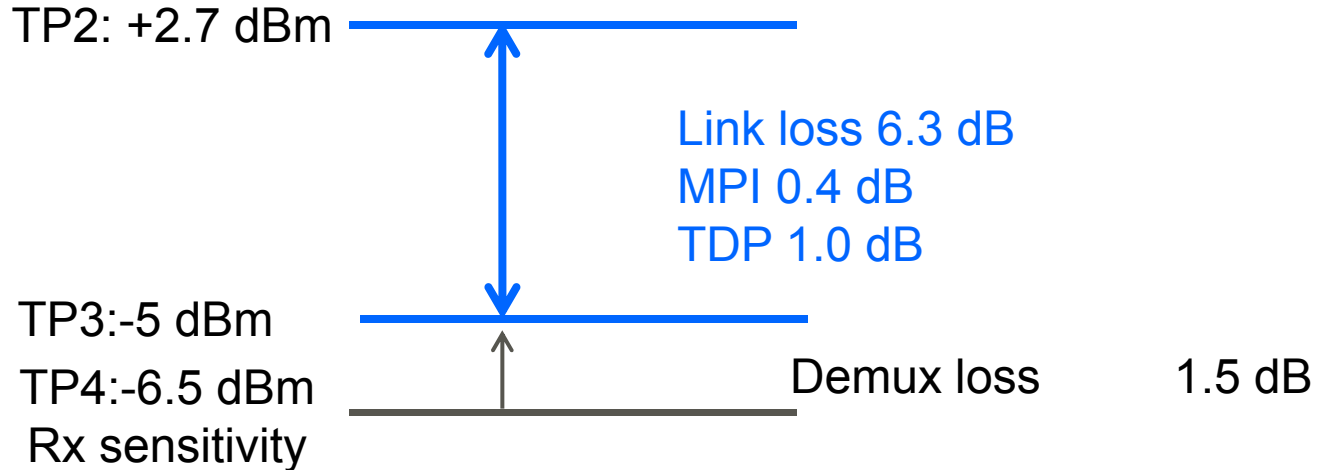
Target BER  $3.3 \times 10^{-3}$

BCH(9193,8192)

# Loss budget consideration

Average output power

Maximum power is below allowable power of +14.1dBm for laser safety.





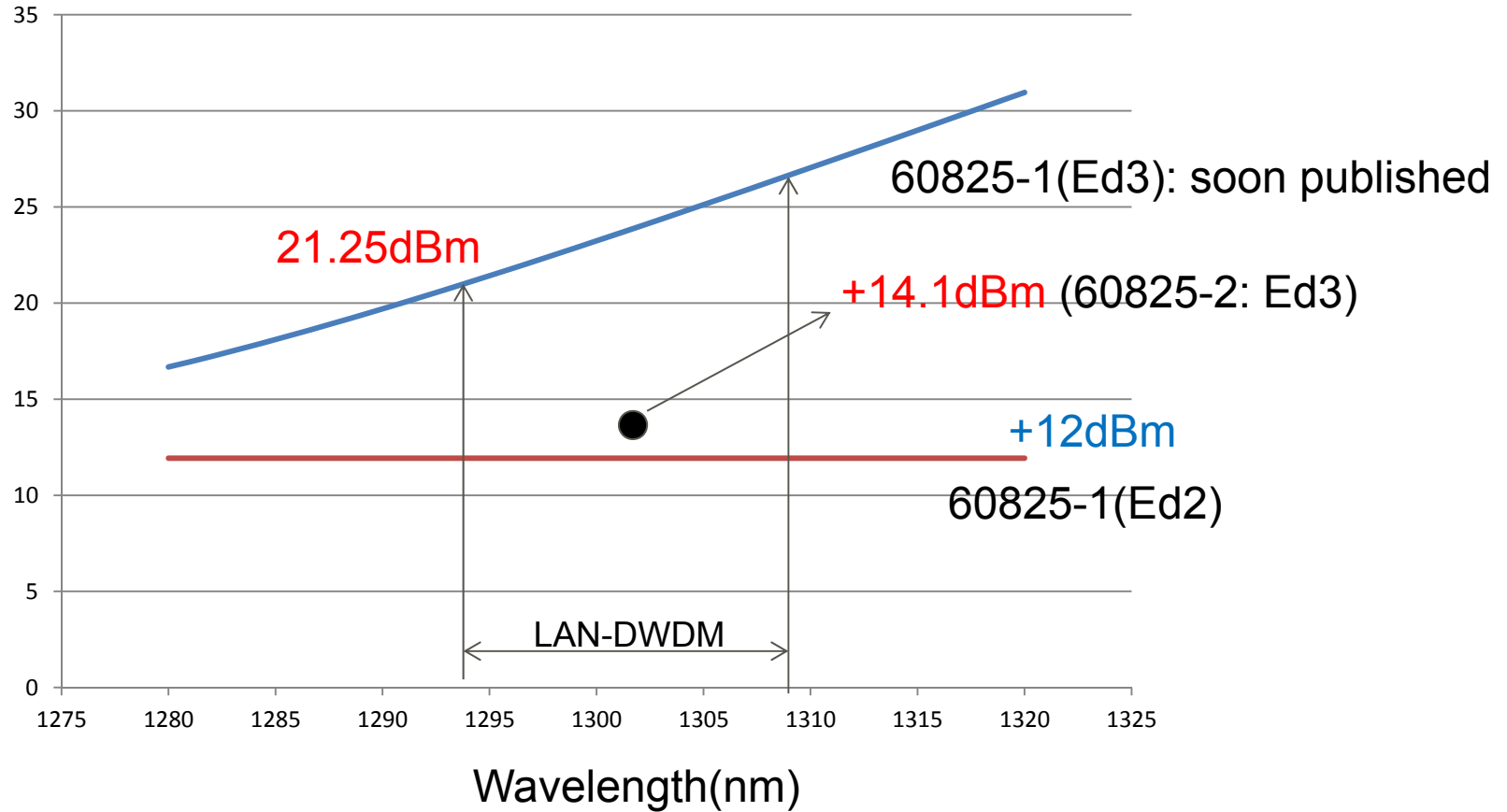
- DMT design tool showed good agreement with experimental result.
- Simulation results based on reasonable improvement and relaxation of parameters demonstrated  $\sim -6.5$  dBm sensitivity.
  - Input referred noise  $20 \text{ pA}/\sqrt{\text{Hz}} \rightarrow 12 \text{ pA}/\sqrt{\text{Hz}}$
  - TX bandwidth  $12 \text{ GHz} \rightarrow 18 \text{ GHz}$
  - RX bandwidth  $16 \text{ GHz} \rightarrow 21 \text{ GHz}$

Thank you

- ✓ Standard group: IEC TC76 WG5
- ✓ Related standards
  - IEC 62805-1(Part1 ):Equip classification & requirements
  - IEC 62805-2(Part2): Optical fiber communications
- ✓ Part1 : under revision for Ed3 “C7 problem”
  - 1300nm SMF Class1:
    - $L=3.9 \cdot 10^{-4} \cdot C4 \cdot C7$  ( $C4=5$ ,  $C7=8$ )
    - =15.6mW (+12dBm)
    - $C7=8+10^{(0.04 \cdot (\lambda-1250nm))}$  [Revision point]
    - $\lambda=1294.53nm$ (Worst)  $\rightarrow$   $L= +21.25dBm$
  - It will be discussed in Tokyo meeting (Nov2014)
- ✓ Part2: 1300nm SMF Class1  $\rightarrow$  +14.1dBm (Be in mind)  
(Distance:70mm, Aperture 7mm)

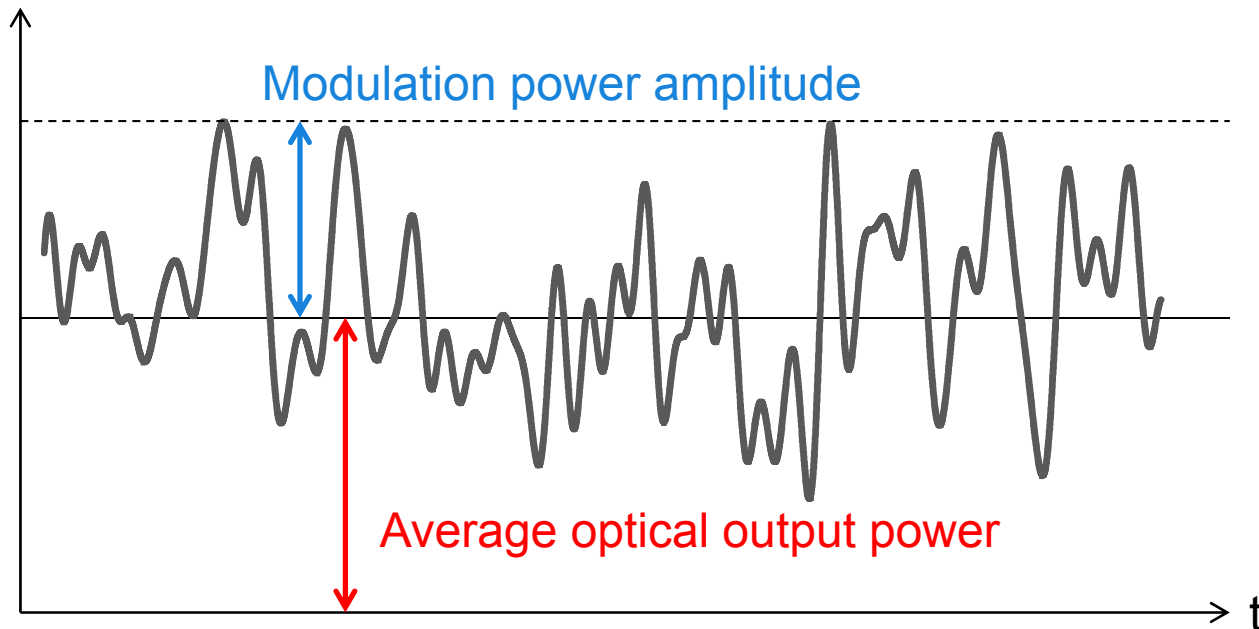
# IEC 60825 specifications

Power(dBm)



Optical modulation index is proposed instead of OMA.

- Optical modulation index  
Optical modulation index  
= Modulation power amplitude / Average optical output power



- Dispersion penalty: about 1 dB
  - Channel specification for dispersion from IEEE802.3ba
  - After 10-km SMF
  - 4ch. LAN-WDM configuration

